



# Final Product/Process Change Notification

Document #:FPCN22966ZV

Issue Date: 31 Mar 2022

<b>Title of Change:</b>	Wafer Fab and Assembly site Transfer for MV7 MOSFET Technology to Global Foundries in New York, US.
<b>Proposed Changed Material First Ship Date:</b>	07 Oct 2022 or earlier if approved by customer
<b>Current Material Last Order Date:</b>	11 Jun 2022 <i>Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability.</i>
<b>Current Material Last Delivery Date:</b>	06 Oct 2022 <i>The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory</i>
<b>Product Category:</b>	Active components – Discrete components
<b>Contact information:</b>	Contact your local onsemi Sales Office or <a href="mailto:Trung.Dang@onsemi.com">Trung.Dang@onsemi.com</a>
<b>PCN Samples Contact:</b>	Contact your local onsemi Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.
<b>Sample Availability Date:</b>	11 Mar 2022
<b>PPAP Availability Date:</b>	30 Apr 2022
<b>Additional Reliability Data:</b>	Contact your local onsemi Sales Office or <a href="mailto:Jacob.Saliba@onsemi.com">Jacob.Saliba@onsemi.com</a>
<b>Type of Notification:</b>	This is a Final Product/Process Change Notification (FPCN) sent to customers. The change will be implemented at 'Proposed Change Material First Ship Date' in compliance to J-STD-46 or ZVEI, or earlier upon customer approval, or per our signed agreements. onsemi will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 45 days of delivery of this notice. To do so, contact <a href="mailto:PCN.Support@onsemi.com">PCN.Support@onsemi.com</a> .
<b>Change Category</b>	
<b>Category</b>	<b>Type of Change</b>
Test Flow	Move of all or part of electrical wafer test and/or final test to a different location/site/subcontractor
Process - Wafer Production	Move of all or part of wafer fab to a different location/site/subcontractor, New wafer diameter
Equipment	Production from a new equipment/tool which uses the same basic technology (replacement equipment or extension of existing equipment pool) without change of process.
Process - Assembly	Move of all or part of assembly to a different location/site/subcontractor., Change of mold compound, Change of specified assembly process sequence (deletion and/or additional process step)
<b>Description and Purpose:</b>	
<p>This Product Change Notification is intended to increase capacity for onsemi automotive MV7 MOSFET technology products by transferring wafer fabrication for these products to the Global Foundries Fab located in New York, US.</p> <p>The changes include transferring wafer fabrication, back grind and back metal, to Global Foundries, and utilizing 300mm instead of 200mm diameter wafers.</p>	

Also include transferring Assembly Final Test location and will use KTMC5900GM EMC as standadization at Suzhou China site , wafer saw and die attach tooling are being updated to accommodate 300mm wafers.

	Before Change	After Change
<b>Wafer Fabrication, Back Grind, Back Metal, Probe Site</b>	onsemi Bucheon, Korea	Global Foundries, US
<b>Wafer Diameter</b>	200mm (existing sites)	300mm (Global Foundries)
<b>Assy&amp;FT site</b>	onsemi Cebu, Philippines	onsemi Suzhou, China
<b>EMC</b>	CEL8240HF10	KTMC5900GM

There is no change to the orderable part number.

There is no product marking change as a result of this change.

<b>Reason / Motivation for Change:</b>	Source/Supply/Capacity Changes Process/Materials Change
<b>Anticipated impact on fit, form, function, reliability, product safety or manufacturability:</b>	The device has been qualified and validated based on the same Product Specification. The device has successfully passed the qualification tests. Potential impacts can be identified, but due to testing performed by onsemi in relation to the PCN, associated risks are verified and excluded.  No anticipated impacts.

<b>Sites Affected:</b>	
<b>onsemi Sites</b>	<b>External Foundry/Subcon Sites</b>
onsemi Suzhou, China	Global Foundries East Fishkill, New York, United States

<b>Marking of Parts/ Traceability of Change:</b>	Material will be traceable with onsemi lot trace code & tracking
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**Reliability Data Summary:**

QV DEVICE NAME FDD86569-F085  
RMS: 68916  
PACKAGE: DPAK

Test	Specification	Condition	Interval	Results
HTRB	JESD22-A108	Ta=175°C, 100% max rated V	1008 hrs	0/231
HTGB	JESD22-A108	Ta=175°C, 100% max rated Vgss	1008 hrs	0/231
HTSL	JESD22-A103	Ta= 175°C	1008 hrs	0/231
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta=+25°C, delta Tj=100°C On/off = 2 min	15000 cyc	0/231
TC	JESD22-A104	Ta= -55°C to +150°C	1000 cyc	0/231
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/231
uHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/231
PC	J-STD-020 JESD-A113	MSL 1 @ 260°C		
RSH	JESD22- B106	Ta = 265C, 10 sec		0/30

**Note: AEC-1 pager is attached:**

To view attachments:

1. Download pdf copy of the PCN to your computer
2. Open the downloaded pdf copy of the PCN
3. Click on the paper clip icon available on the menu provided in the left/bottom portion of the screen to reveal the Attachment field
4. Then click on the attached file.



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## Electrical Characteristics Summary:

Electrical characteristics are not impacted.

## List of Affected Parts:

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the [PCN Customized Portal](#).

Current Part Number	New Part Number	Qualification Vehicle
FDD86367-F085	NA	FDD86569-F085
FDD86569-F085	NA	FDD86569-F085
FDD86369-F085	NA	FDD86569-F085

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**Appendix A: Changed Products**

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**Issue Date: Mar 31, 2022**

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Product	Customer Part Number	Qualification Vehicle	New Part Number	Replacement Supplier
FDD86367-F085		FDD86569-F085	NA	
FDD86369-F085		FDD86569-F085	NA	
FDD86569-F085		FDD86569-F085	NA	